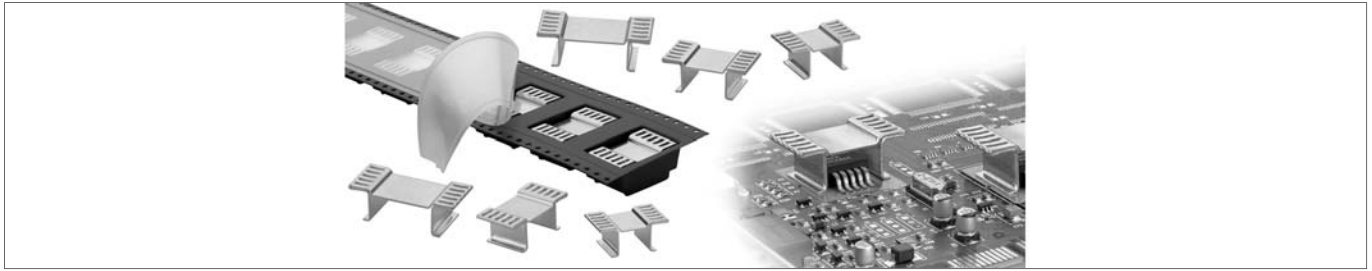


## Heatsinks for D PAK and others



- copper heatsinks with excellent heat conductivity
- direct mounting on printed circuit through solderable surface
- especially suitable for SMD components of type D PAK (TO 252), D<sup>2</sup> PAK (TO 263), D<sup>3</sup> PAK (TO 268), SOT 669 LF PAK, SO IC-8 FL MP, Power SO-8, Power SO-10, Power SO-20, Power SO-36, SO-14, SO-16, SOT 223 etc
- available standard packing: loose parts or reel
- special packing like magazine, tray etc. on request; - special versions according to customers specifications
- **tape width:** 44 mm, **reel diameter:** 330 mm, **quantity:** FK 244 08 = 450, FK 244 13 = 200

<b>art. no.</b>				<b>31,5 K/W</b>
<b>FK 244 08 D PAK ...</b> weight: 2 g				
<b>art. no.</b>				<b>25 K/W</b>
<b>FK 244 13 D PAK ...</b> weight: 3.3 g				
<b>art. no.</b>				<b>29,3 K/W</b>
<b>FK 244 08 D2 PAK ...</b> weight: 2.2 g				
<b>art. no.</b>				<b>22,8 K/W</b>
<b>FK 244 13 D2 PAK ...</b> weight: 3.6 g				
<b>art. no.</b>				<b>26 K/W</b>
<b>FK 244 08 D3 PAK ...</b> weight: 2.5 g				
<b>art. no.</b>				<b>19,5 K/W</b>
<b>FK 244 13 D3 PAK ...</b> weight: 3.9 g				
<b>please indicate:</b>	<b>... packing (option)</b> <b>TR=tape and reel</b>			

**surface treatment:** solderable  
**material:** copper (Cu)  
**material thickness:** 0.6 mm

**C 17**

Heatsinks for transistors  
 Heatsinks for TO 5 and TO 18  
 Attachable heatsinks  
 Finger-shaped heatsinks

→ C 4 - 9  
 → C 15 - 16  
 → C 10 - 14  
 → C 2 - 3

High capacity heatsinks  
 Designed parts out of aluminium  
 Heatsink profile-overview  
 Classification table

→ A 56 - 57  
 → A 135  
 → A 13 - 16  
 → A 18 - 20